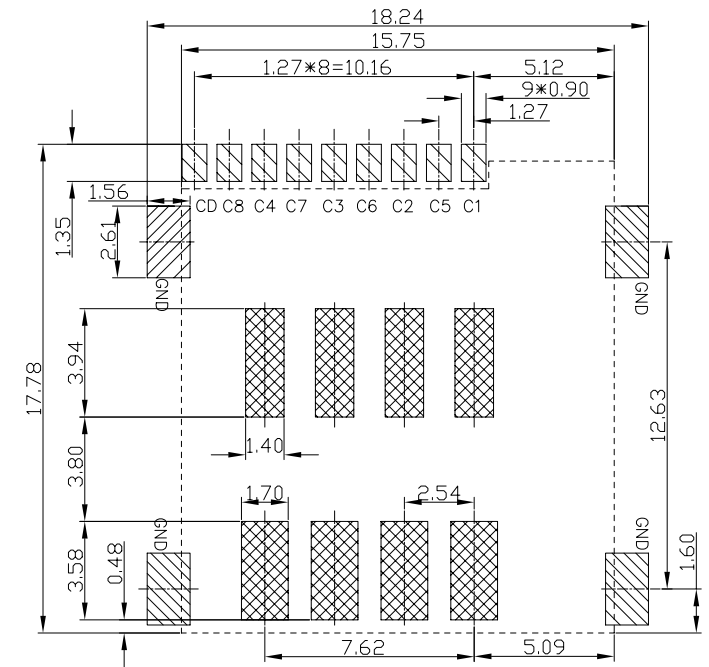
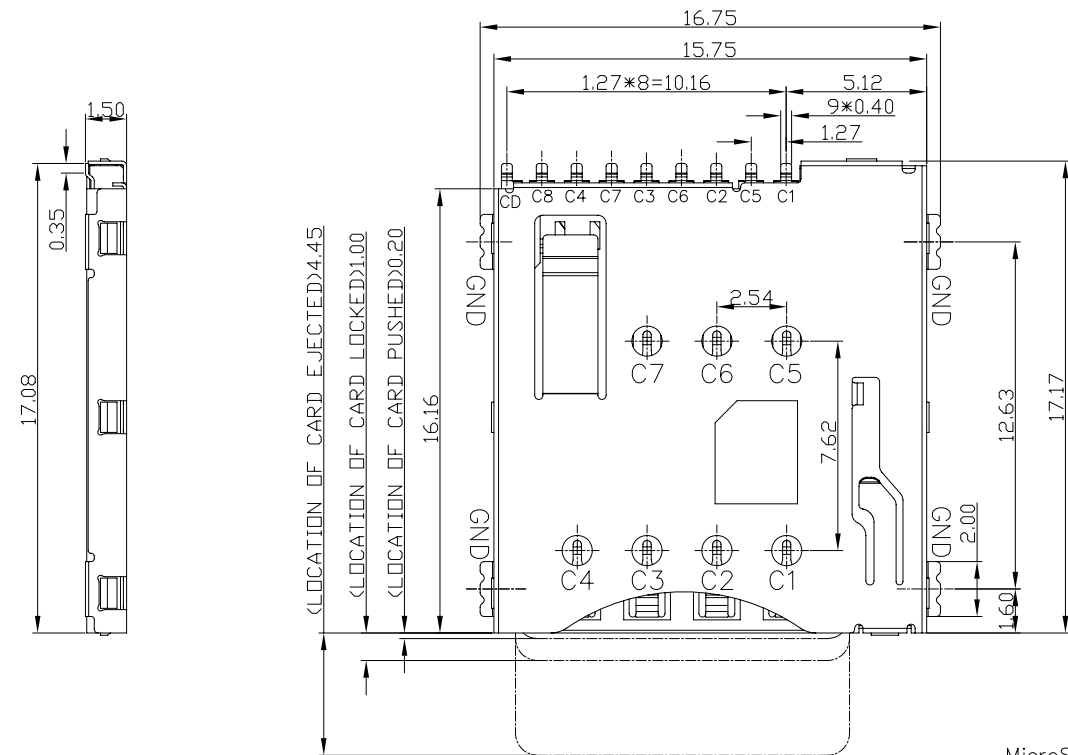


ÓÉ Foxit PDF Editor ±â¼-
°æËÛÜÖÐ (c) by Foxit Software Company, 2004
½00ÁÖÚ/EA¹À½

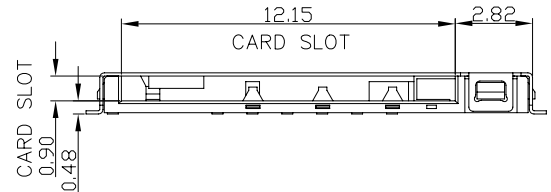
REV.	ECN	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A		NEW RELEASE	2016.03.09			



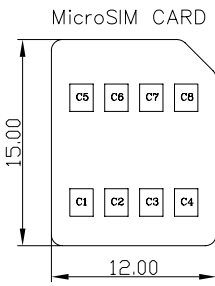
RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE(TOLERANCE ±0.05)

TECHNICAL CHARACTERISTICS

- General Characteristics
Dimensions: 15.75LX17.17WX1.50H mm
Weight: Approx 0.4±0.1g
Durability:1500 cycles min.
- Electrical Characteristics
Contact resistance;
Date Contact:150mΩ max
CD Switch: 500mΩ max
Insulation resistance:>1000MΩ/500V DC
- Solderability
Vapor phase: 215°C,30sec.Max
IR reflow: 250°C,5sec.Max
Manual soldering: 370°C,3sec.Max
- Environmental Characteristics
Operating temperature: -40°C~+85°C
Operating humidity: 10%~+95%RH



MicroSIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved



SCALE 1:2

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	COIL SPRING	1	SWP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	

MILLIMETERS	INCH	UNITS			
X° ± 2'	X° ± 2'	MM			
.X ± 0.30	.XX ± 0.012	MAT'L			
.XX ± 0.20	.XXX ± 0.008	SEE NOTES			
.XXX ± 0.10	.XXXX ± 0.004	FINISH			
		SEE NOTES			
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF Jin Bi Lai Electronics Group COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF Jin Bi Lai Electronics Group IS PROHIBITED.					
		PART NUMBER:	102011422		TITLE: MicroSIM PUSH H1.5(8P)
		APPD:	Sean		DWG NO.: A-102011422
		CHKD:			
		DR:	Yang		
			SCALE	SHEET	REV.
			1:1	1	A